Intel[®]SK70740/SK70744 HDSL2 Modem Chip Set

Product Overview

The Intel[®] SK70740/SK70744 chip set is an ANSI HDSL2 modem that provides symmetric full-duplex, T1 transmission over a single twisted pair. The device is capable of providing Overlapped PAM Transmission with Interlocking Spectrum (OPTIS) power spectral density (PSD). This HDSL2 modem solution consists of two chips:

- SK70740 Analog Front End (AFE)
- SK70744 Transceiver/Framer

The AFE receives a pulse width modulated data stream from the digital transceiver. Switched capacitor filters shape the transmitted signal to suppress out-of-band noise. The receive channel consists of an automatic gain control (AGC) stage and an analog to digital (A/D) converter. The dynamic range of the receive channel is over 80 dB.

The core of the Transceiver/framer is a Trellis Coded PAM modulator/demodulator. HDSL2 utilizes shaped PAM-16 modulation to minimize interference into other services. In addition, Trellis Coding (TC) and Viterbi Decoding allows the system to provide a high signal-to-noise margin in the presence of crosstalk noise from other services.

The frame mapping function inserts and recovers the HDSL2 overhead. Interrupt alarms are provided for loss-of-sync and CRC errors.



The system also has read/write register access to the Embedded Operations Channel (EOC) bits within the HDSL2 frame. A synchronous TDM interface allows the chip set to be used with common T1 framers.

Key Applications

- Full rate T1 transport systems
- Multi-channel digital pair gain systems
- WAN access for LAN routers and switches
- Integrated access devices
- Wireless access systems



SK70744

SK70740

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Deploying HDSL2 in a central-office-based DSLAM environment allows local exchange carriers the option to deploy symmetric guaranteed services for businesses. HDSL2 was designed to be spectrally compatible with other services such as HDSL, ADSL, and T1. As such, HDSL2 can be deployed without disrupting other DSL services in the local loop.

CENTRAL OFFICE BUILDING

HDSL2 TO

BUSINESS

CUSTOMERS



HDSL2 CPE Modem in an Office Application

A HDSL2 CPE modem will allow symmetric data rates to an office setting of 1.544 Mbps. This can serve as a complete voice/data pipeline to an office. With a single HDSL2 CPE modem, users can get multiple phone lines and PC Ethernet connections.



HDSL2 Based T1 Delivery

The original T1 carrier required two twisted pairs, plus repeaters spaced at 3,000-foot intervals. First-generation HDSL eliminated the need for repeaters in spans up to 12,000 feet using two twisted pairs. Now, HDSL2 delivers T1 payloads on a single twisted pair.

Features	Benefits
HDSL2	 Allows symmetric T1 transport over a single twisted pair
 Supports ANSI.T1E1.418 	 Enables interoperability with other HDSL2 standard based equipment
Automatic activation	 Helps minimize the load on the system processor
Programmable	 Supports both remote and central office applications
 Adaptive equalization and echo canceller 	 Maintains excellent transmission performance with changing noise and line characteristics
OPTIS	 Power spectral density designed to coexist with preexisting services in a multi-pair bundle
 Generic µP port 	 Interfaces with either Intel or Motorola* 8-bit microcontrollers

Support Products

- SK70740/44 Datasheet
- HDSL2 White Paper

- Product Presentation
- HDSL2 Frequently Asked Questions (FAQs)

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